

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)
30	0.099 at V _{GS} = 4.5 V	1.2 ^a	3.5
	0.140 at V _{GS} = 2.5 V	1.0	

FEATURES

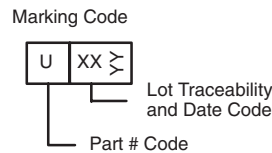
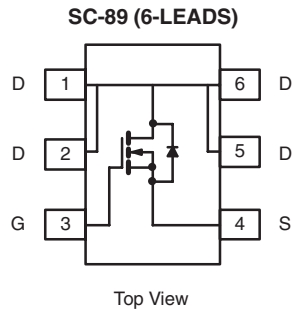
- Halogen-free Option Available
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested



RoHS
COMPLIANT

APPLICATIONS

- Load Switch for Portable Devices



Ordering Information: Si1070X-T1-E3 (Lead (Pb)-free)
Si1070X-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted				
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	30	V	
Gate-Source Voltage	V _{GS}	± 12		
Continuous Drain Current (T _J = 150 °C) ^a	I _D	T _A = 25 °C	A	
		T _A = 70 °C		
Pulsed Drain Current	I _{DM}	6		
Avalanche Current	I _{AS}	9		
Repetitive Avalanche Energy	E _{AS}	4.01	mJ	
Continuous Source-Drain Diode Current	I _S	T _A = 25 °C	A	
		T _A = 70 °C		
Maximum Power Dissipation ^a	P _D	T _A = 25 °C	W	
		T _A = 70 °C		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	R _{thJA}	t ≤ 5 s	440	530	°C/W
		Steady State	540	650	

Notes:

- Based on T_C = 25 °C.
- Surface Mounted on 1" x 1" FR4 board.
- t = 5 s.
- Maximum under Steady State conditions is 650 °C/W.

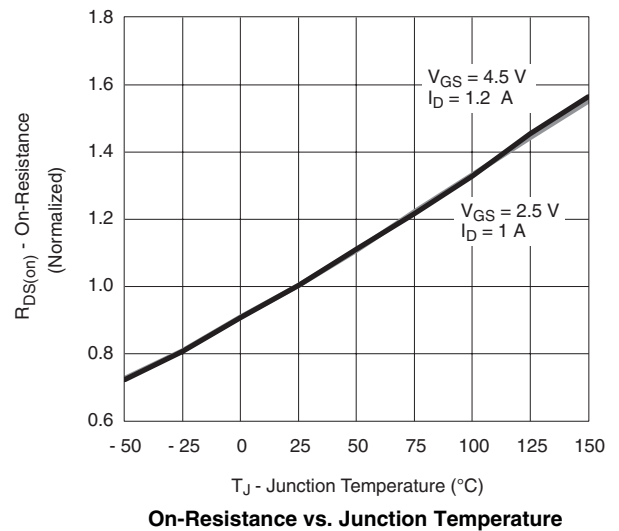
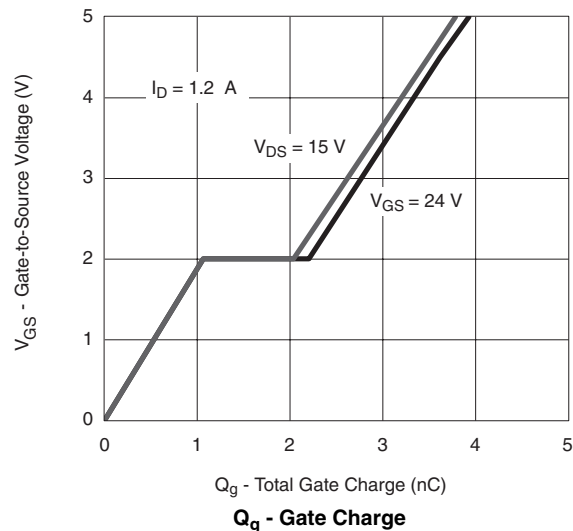
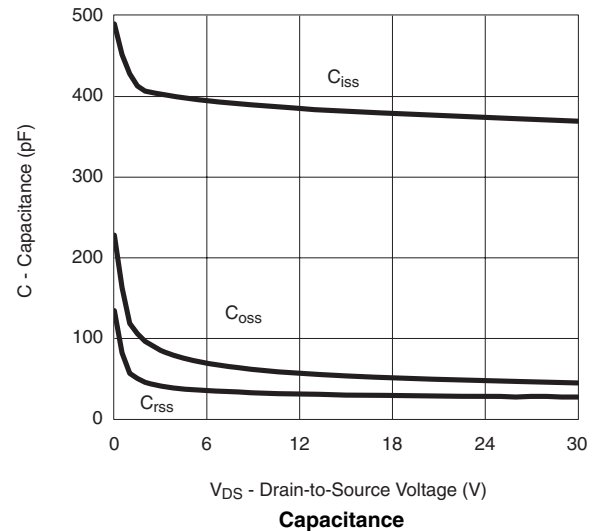
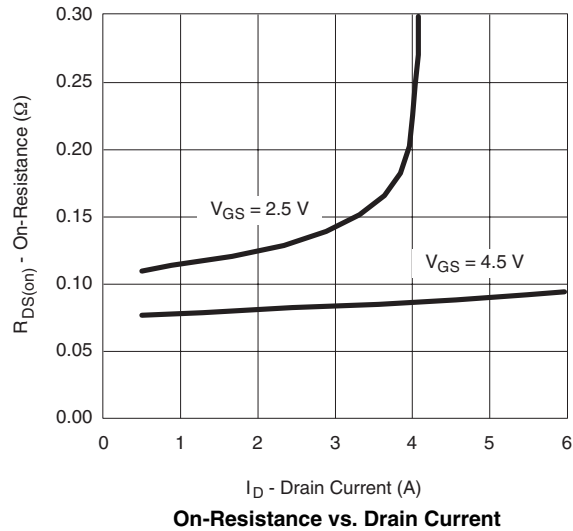
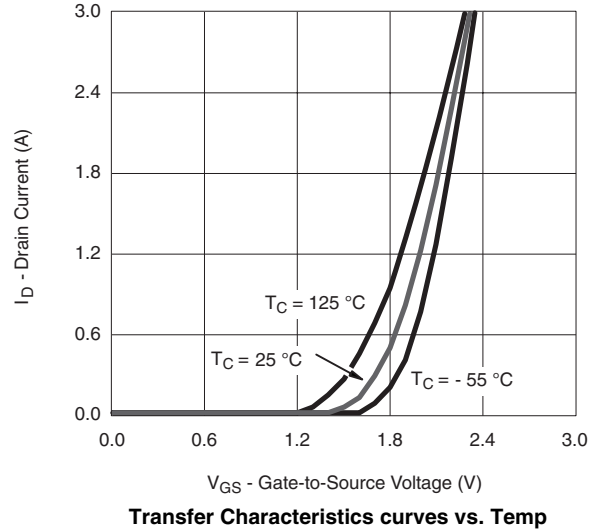
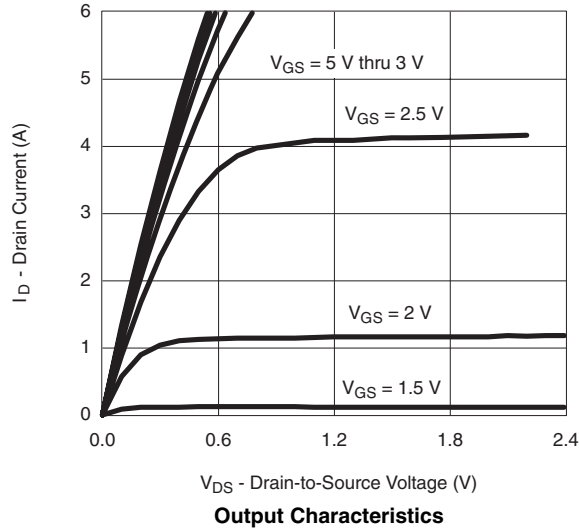
SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	30			V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250\text{ }\mu\text{A}$		24.5		mV/°C
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			-3.81		
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	0.7		1.55	V
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 12\text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}$			1	nA
		$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}, T_J = 85\text{ }^\circ\text{C}$			10	μA
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq 5\text{ V}, V_{GS} = 4.5\text{ V}$	6			A
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = 4.5\text{ V}, I_D = 1.2\text{ A}$		0.082	0.099	Ω
		$V_{GS} = 2.5\text{ V}, I_D = 1.0\text{ A}$		0.116	0.140	
Forward Transconductance	g_{fs}	$V_{DS} = 15\text{ V}, I_D = 1.2\text{ A}$		5		S
Dynamic^b						
Input Capacitance	C_{iss}	$V_{DS} = 15\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$		385		pF
Output Capacitance	C_{oss}			55		
Reverse Transfer Capacitance	C_{rss}			30		
Total Gate Charge	Q_g	$V_{DS} = 15\text{ V}, V_{GS} = 5\text{ V}, I_D = 1.2\text{ A}$		3.8	8.3	pC
		$V_{DS} = 15\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 4.6\text{ A}$		3.5	4.1	
Q_{gs}			1.1			
Q_{gd}			0.98			
Gate Resistance	R_g	$f = 1\text{ MHz}$		4.7	6.2	Ω
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 15\text{ V}, R_L = 15\text{ }\Omega$ $I_D \cong 1.0\text{ A}, V_{GEN} = 4.5\text{ V}, R_g = 1\text{ }\Omega$		10	15	ns
Rise Time	t_r			22	33	
Turn-Off Delay Time	$t_{d(off)}$			14	21	
Fall Time	t_f			6	9	
Drain-Source Body Diode Characteristics						
Pulse Diode Forward Current ^a	I_{SM}				6	A
Body Diode Voltage	V_{SD}	$I_S = 1.2\text{ A}$		0.8	1.2	V
Body Diode Reverse Recovery Time	t_{rr}	$I_F = 3.8\text{ A}, di/dt = 100\text{ A}/\mu\text{s}$		19.4	29.5	nC
Body Diode Reverse Recovery Charge	Q_{rr}			18.43	27.5	ns
Reverse Recovery Fall Time	t_a			16.4		
Reverse Recovery Rise Time	t_b			3		

Notes:

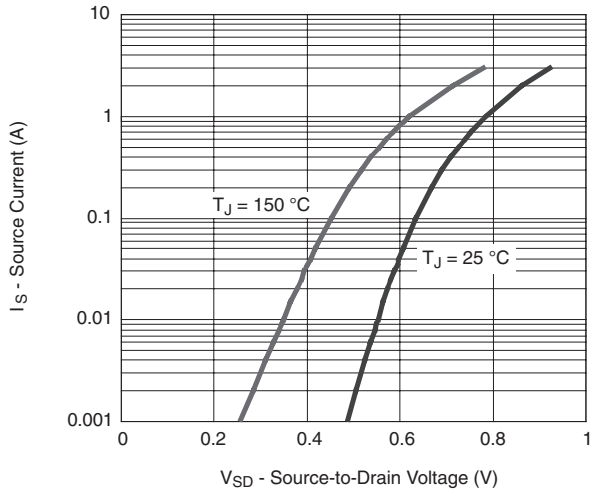
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

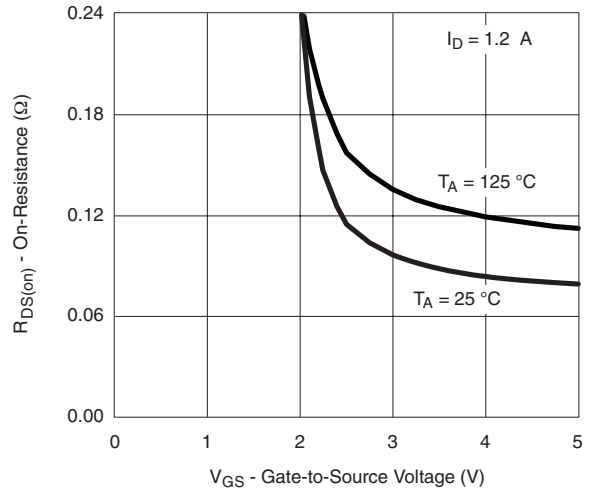
TYPICAL CHARACTERISTICS $T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted



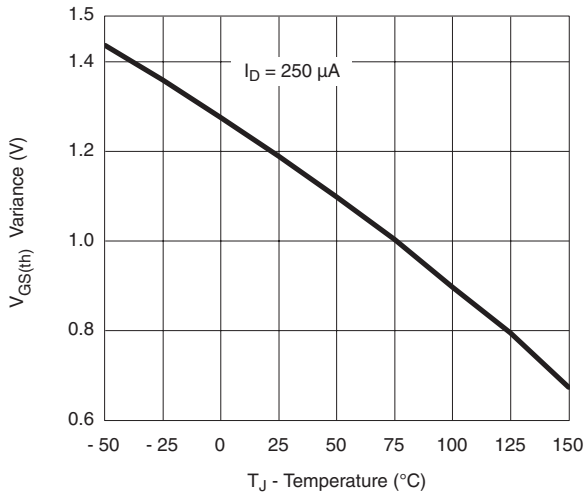
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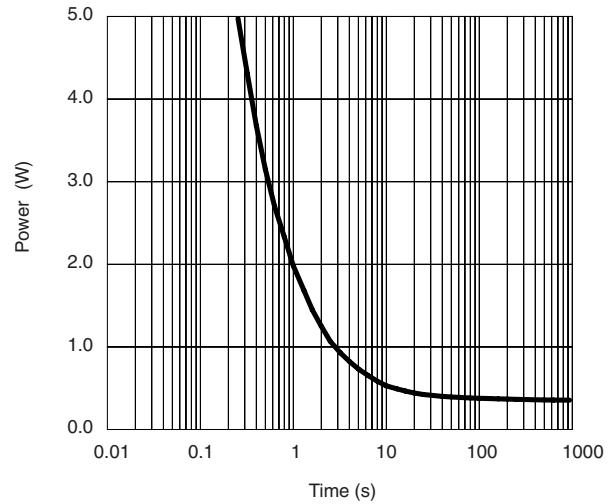
Source-Drain Diode Forward Voltage



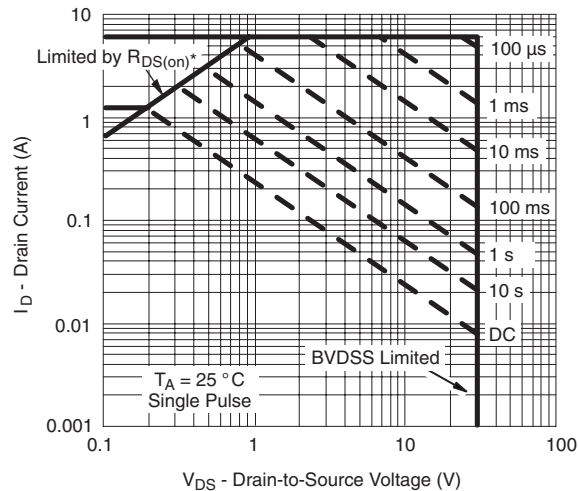
$R_{DS(on)}$ vs V_{GS} vs Temperature



Threshold Voltage



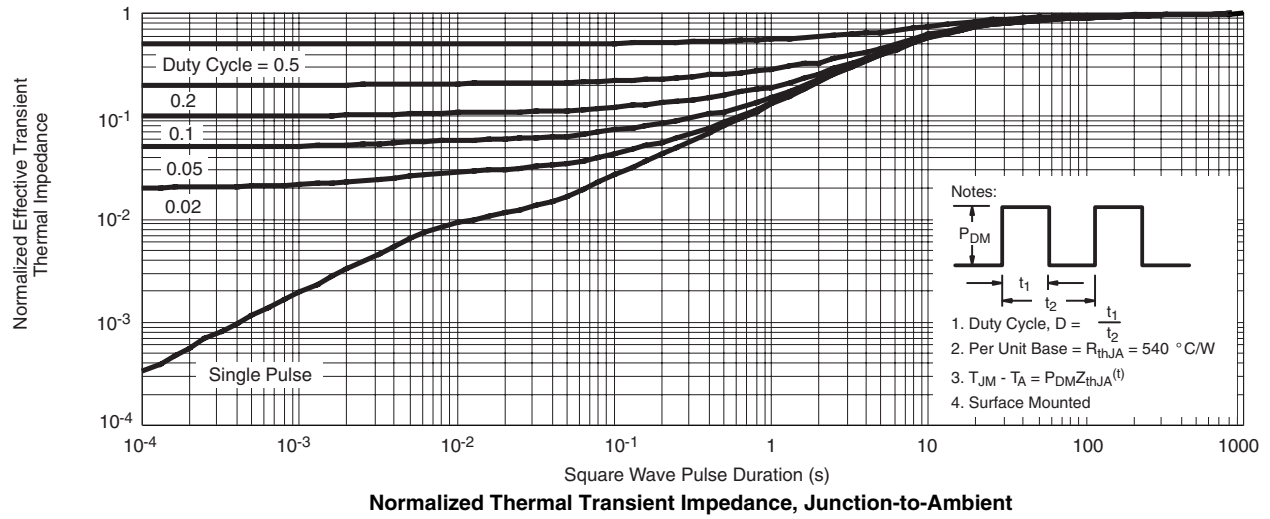
Single Pulse Power



* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

TYPICAL CHARACTERISTICS $T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted



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